

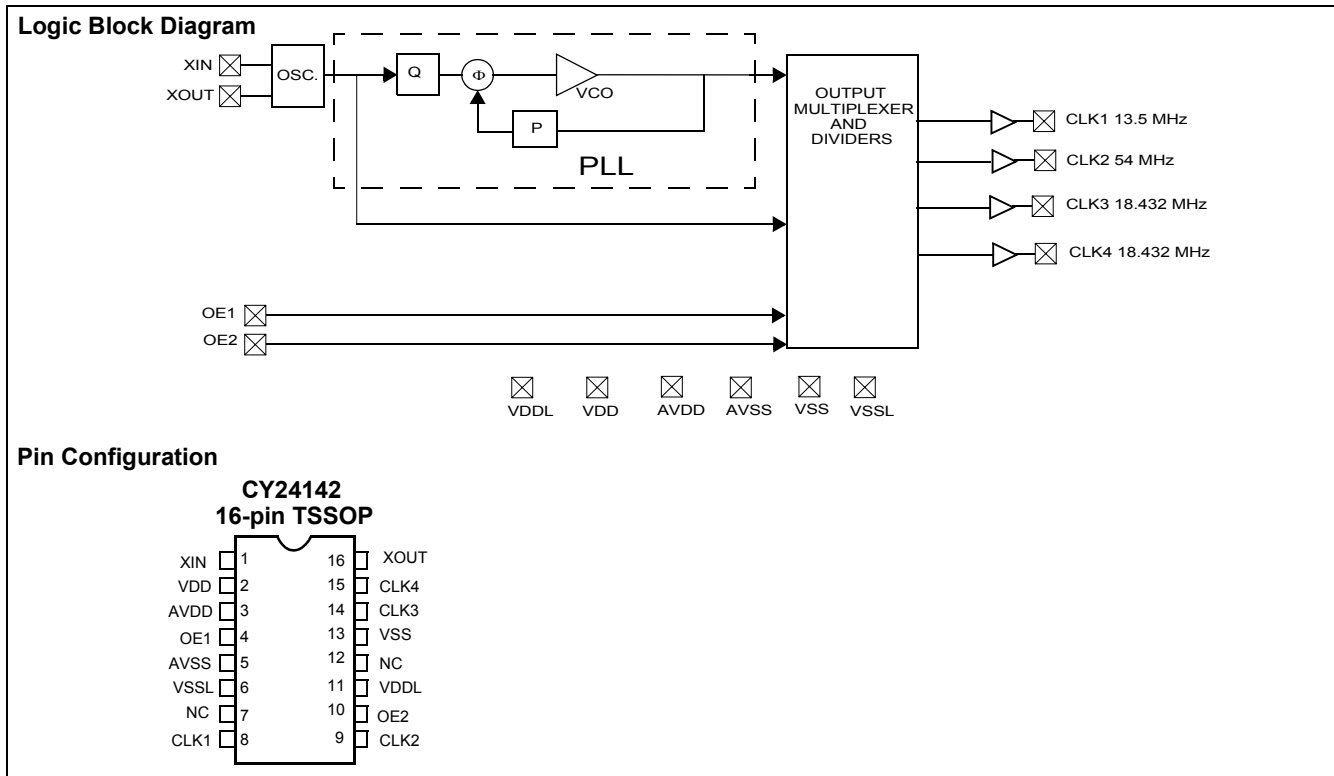
MediaClock™ Multimedia Clock Generator

Features

- Integrated phase-locked loop (PLL)
- Low-jitter, high-accuracy outputs
- 3.3V operation

Benefits

- Integrated high-performance PLL eliminates the need for — external loop filter components
- Meets critical timing requirements in complex system designs
- Enables application compatibility



Frequency Table

Part Number	Outputs	Input Frequency	Output Frequency Range
CY24142-01	4	18.432	13.5 MHz, 54 MHz, 2 x 18.432 MHz

Output Enable Options^[1]

OE2	OE1	CLK1	CLK2	CLK3	CLK4	Unit
0	0	13.5	OFF	OFF	OFF	MHz
0	1	13.5	54	18.432	OFF	MHz
1	0	13.5	OFF	OFF	18.432	MHz
1	1	13.5	54	18.432	18.432	MHz

Note:

1. Output driven LOW when "OFF."

Pin Description

Pin Name	Pin Number	Pin Description
XIN	1	Crystal Input.
V _{DD}	2	Voltage Supply.
AV _{DD}	3	Analog Voltage Supply.
OE1	4	Output Enable 1, 0 = CLK 2 and CLK3 off, 1 = CLK 2 and CLK3 on; weak internal pull-down.
AV _{SS}	5	Analog Ground.
V _{SSL}	6	V _{DDL} Ground.
NC	7	No Connect; leave floating.
CLK1	8	13.5-MHz Clock Output.
CLK2	9	54-MHz Clock Output; controlled by OE1.
OE2	10	Output Enable 2, 0 = CLK4 off, 1 = CLK4 on; weak internal pull-down.
V _{DDL}	11	Voltage Supply.
NC	12	No Connect; leave floating.
V _{SS}	13	Ground.
CLK3	14	18.432-MHz Buffered Reference Output, controlled by OE1.
CLK4	15	18.432-MHz Buffered Reference Output, controlled by OE2.
XOUT	16	Crystal Output.

Layout Recommendations

The X_{IN} and X_{OUT} traces and pads as well as the crystal should be placed away from any clock traces or noise sources. Noise coupling into the X_{IN} and X_{OUT} traces may cause start-up problems. A pad for a resistor to ground should be laid out on the X_{OUT} trace to be stuffed if necessary, in case start-up issues occur.



Absolute Maximum Conditions

(Above which the useful life may be impaired. For user guidelines, not tested.)

Supply Voltage (V_{DD} , AV_{DD} , V_{DDL}) -0.5 to +7.0V
 DC Input Voltage -0.5V to $V_{DD} + 0.5$

Storage Temperature (Non-Condensing).... -55°C to +125°C
 Junction Temperature -40°C to +125°C
 Data Retention @ $T_j=125^\circ\text{C}$ > 10 years
 Package Power Dissipation 350 mW
 ESD (Human Body Model) MIL-STD-883..... 2000V

Recommended Crystal Specifications

Parameter	Description	Comments	Min.	Typ.	Max.	Unit
F_{NOM}	Nominal crystal frequency	Parallel resonance, fundamental mode, AT cut		18.432		MHz
C_{LNOM}	Nominal load capacitance			14		pF
R_1	Equivalent series resistance (ESR)	Fundamental mode			25	Ω
R_3/R_1	Ratio of third overtone mode ESR to fundamental mode ESR	Ratio used because typical R_1 values are much less than the maximum spec	3			
DL	Crystal drive level	No external series resistor assumed		0.5	2	mW

Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Unit
V_{DD} , AV_{DD} , V_{DDL}	Supply Voltage	3.15	3.45	3.6	V
T_A	Ambient Temperature	0		85	$^\circ\text{C}$
C_{LOAD}	Max. Load Capacitance			15	pF
T_{PU}	Power-up time for all V_{DD} s to reach minimum specified voltage (power ramps must be monotonic)	0.05		500	ms

DC Electrical Specifications

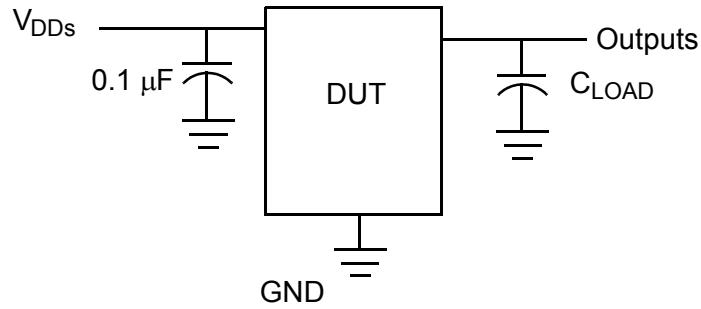
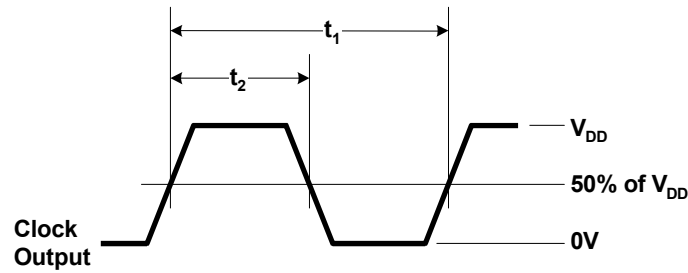
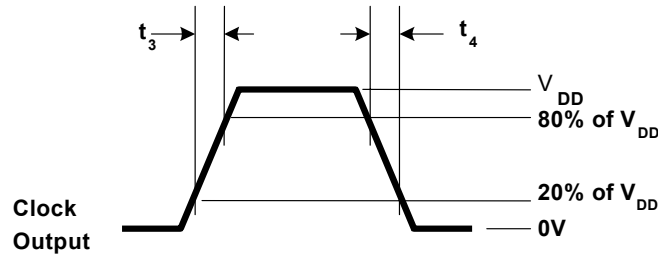
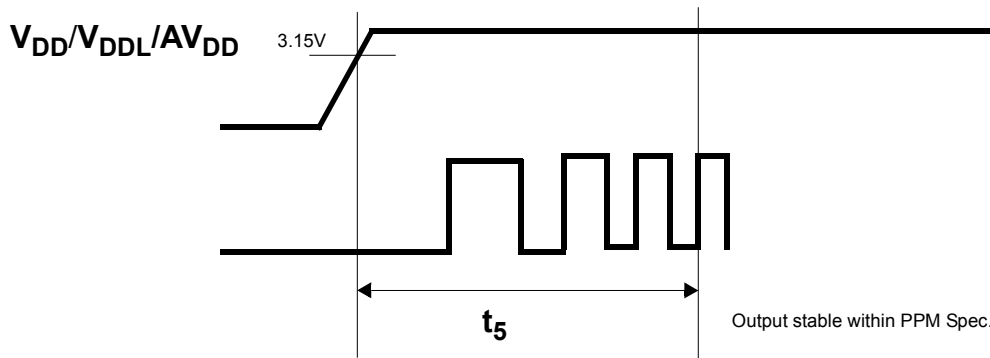
Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
$I_{OH}^{[2]}$	Output High Current	$V_{OH} = V_{DD} - 0.5$, $V_{DD}/V_{DDL} = 3.45\text{V}$	12	24		mA
$I_{OL}^{[2]}$	Output Low Current	$V_{OL} = 0.5$, $V_{DD}/V_{DDL} = 3.45\text{V}$	12	24		mA
I_{IH}	Input High Current	$V_{IH} = V_{DD}$			50	μA
I_{IL}	Input Low Current	$V_{IL} = 0\text{V}$		5	10	μA
V_{IH}	Input High Voltage	CMOS levels, 70% of V_{DD}	0.7			V_{DD}
V_{IL}	Input Low Voltage	CMOS levels, 30% of V_{DD}			0.3	V_{DD}
I_{VDD}	Supply Current	AV_{DD}/V_{DD} Current			25	mA
I_{VDDL}	Supply Current	V_{DDL} Current			20	mA
R_{DOWN}	Pull-down resistor on Inputs	$V_{DD} = 3.15$ to 3.6V , measured $V_{IN} = 3.45\text{V}$		100	150	$\text{k}\Omega$
$C_{XTAL}^{[2]}$	Crystal Load Capacitance	Total effective load of internal load caps		12.9		pF

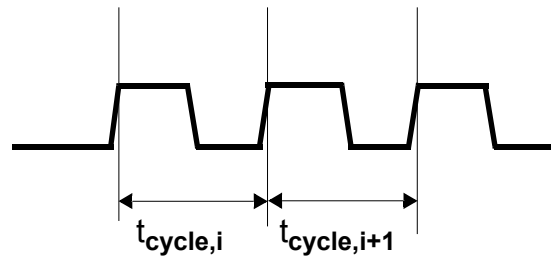
Cycle-Cycle Jitter Specifications ($V_{DD} = 3.15\text{V} - 3.6\text{V}$)

Parameter	Description	Conditions	1 σ	Typ.	Max.	Unit
t_g	Clock Jitter–peak-peak	Cycle-Cycle Jitter–18.432 MHz	20	120	200	ps
t_g	Clock Jitter–peak-peak	Cycle-Cycle Jitter–54 MHz	40	150	250	ps
t_g	Clock Jitter–peak-peak	Cycle-Cycle Jitter–13.5 MHz	20	120	200	ps

Note:

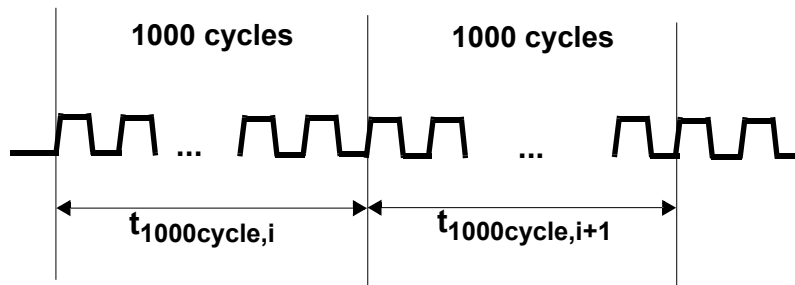
2. Guaranteed by characterization, not 100% tested.

Test and Measurement Set-up

Voltage and Timing Definitions

Figure 1. Duty Cycle Definition

Figure 2. $ER = (0.6 \times V_{DD}) / t_3$, $EF = (0.6 \times V_{DD}) / t_4$

Figure 3. PLL Lock Time



$$t_6 = t_{\text{cycle},i} - t_{\text{cycle},i+1}$$

Figure 4. 54MOUT, LCLK Cycle-to-Cycle Jitter

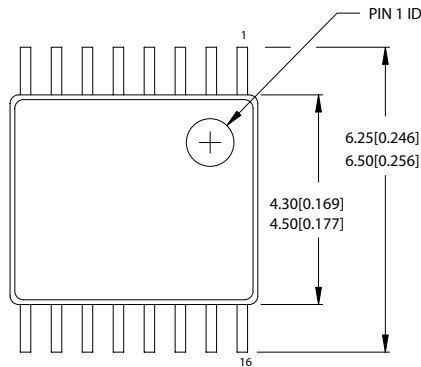


$$t_7 = t_{1000\text{cycle},i} - t_{1000\text{cycle},i+1}$$

Figure 5. 54MOUT, LCLK 1000 Cycle Jitter

Ordering Information

Ordering Code	Package Type	Operating Range	Operating Voltage
Standard			
CY24142ZC-01	16-pin TSSOP	Commercial	3.45V
CY24142ZC-01T	16-pin TSSOP – Tape and Reel	Commercial	3.45V
Lead-free			
CY24142ZXC-01	16-pin TSSOP	Commercial	3.45V
CY24142ZXC-01T	16-pin TSSOP – Tape and Reel	Commercial	3.45V

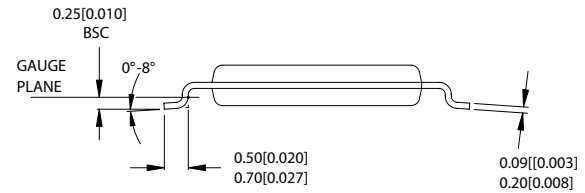
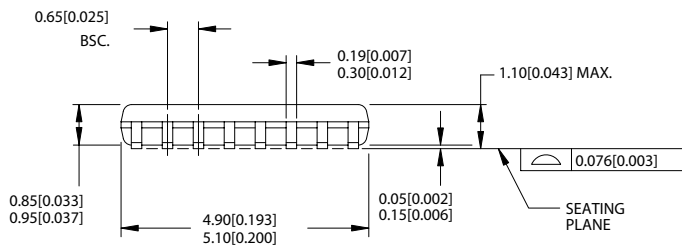
Package Drawing and Dimensions
16-lead TSSOP 4.40 MM Body Z16.173


DIMENSIONS IN MM[INCHES] MIN.

MAX.

REFERENCE JEDEC MO-153

PACKAGE WEIGHT 0.05gms



51-85091-*A

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Document History Page

Document Title: CY24142 MediaClock™ Multimedia Clock Generator				
Document Number: 38-07532				
REV.	ECN No.	Issue Date	Orig. of Change	Description of Change
**	127352	09/08/03	RGL	New Data Sheet
*A	130343	10/13/03	RGL	Changed the part number from CY24142-1 to CY24142-01.
*B	310574	See ECN	RGL	Added Lead-free